

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	24	("3659386" "3906678" "3913271" "4141180" "4680893" "5232875" "5329732" "5551986" "5554064" "5562524" "5616063" "5618227" "5649854" "5655954" "5679059" "5718618" "5804507" "5827110" "5830045" "5885138" "5897426" "6354922" "6358126" "6358128"). PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/11 10:45
L9	1	("6629883").URPN.	USPAT	OR	OFF	2005/03/11 10:46
L11	74	451/73.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/11 13:04
L12	987	451/285.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/11 13:05
L13	316	451/286.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/11 13:05
L14	1202	451/287.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/11 13:05
L15	6880859	"8"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/11 13:05
L16	1244	451/288.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/11 13:06
L17	392	451/289.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/11 13:06
L18	268	451/290.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/11 13:06

S1	4	("20010044266" "5738574").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 07:04
S2	315	451/66.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/02 06:38
S3	413	451/67.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/20 15:31
S4	914	15/77.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/21 11:03
S6	232	15/88.2.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/21 11:07
S7	0	15/88.7.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/21 11:08
S8	613	15/88.3.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/21 11:10
S9	506	15/102.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/21 11:11
S10	10	("4350954" "5213118" "5299584" "5329732" "5333413" "5421768" "5425793" "5456627" "5498294" "5518542").PN.	USPAT	OR	OFF	2004/10/21 12:49
S11	78	"5655954".URPN.	USPAT	OR	OFF	2004/10/21 12:51
S12	2219	134/902.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 07:14
S13	165	134/77.ccls.	USPAT	OR	OFF	2004/10/25 07:21

S14	60	134/78.ccls.	USPAT	OR	OFF	2004/10/25 07:30
S15	102	134/79.ccls.	USPAT	OR	OFF	2004/10/25 07:37
S16	250	134/140.ccls.	USPAT	OR	OFF	2004/10/25 07:46
S17	216	134/149.ccls.	USPAT	OR	OFF	2004/10/25 07:49
S18	143	134/158.ccls.	USPAT	OR	OFF	2004/10/25 07:55
S19	1022	134/6.ccls.	USPAT	OR	OFF	2004/10/25 08:17
S20	0	134/22.ccls.	USPAT	OR	OFF	2004/10/25 08:17
S21	592	134/32.ccls.	USPAT	OR	OFF	2004/10/25 08:34
S22	467	134/33.ccls.	USPAT	OR	OFF	2004/10/25 08:38
S23	320	438/690.ccls.	USPAT	OR	OFF	2004/10/25 08:46
S24	1612	438/692.ccls.	USPAT	OR	OFF	2004/10/25 08:48
S25	2202	438/690-693.ccls.	USPAT	OR	OFF	2004/10/25 08:48
S26	1685	438/690-693.ccls. and (cleaning adj5 substrate wafer)	USPAT	OR	OFF	2004/10/25 08:50
S27	422	451/67.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/02 06:38
S28	0	15/88.7.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/02 06:57
S29	12897	wakabayashi.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 15:01
S30	8355	polishing adj apparatus .	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 15:01
S31	30	S29 and S30	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 15:02